

HPI

TE Internal #: 4-2390138-9

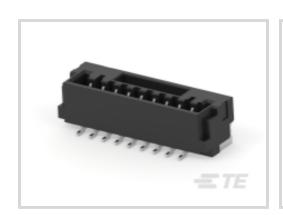
HPI, PCB Mount Header, Wire-to-Board, 9 Position, .049 in [1.25 mm] Centerline, Fully Shrouded, Tin, Surface Mount, Power &

Signal, Black

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Connectors > PCB Connectors > PCB Headers & Receptacles











Connector System: Wire-to-Board

Number of Positions: 9

Number of Rows: 1

Centerline (Pitch): 1.25 mm [.049 in]

Termination Method to Printed Circuit Board: Surface Mount

Features

Product Type Features

| Connector System | Wire-to-Board |
|---------------------------------------|-----------------------|
| Header Type | Fully Shrouded |
| Sealable | No |
| Connector & Contact Terminates To | Printed Circuit Board |
| PCB Connector Assembly Type | PCB Mount Header |
| Configuration Features | |
| Number of Positions | 9 |
| Number of Rows | 1 |
| Electrical Characteristics | |
| Termination Resistance | 20 mΩ |
| Insulation Resistance | 100 ΜΩ |
| Dielectric Withstanding Voltage (Max) | 500 V |

Black

Body Features

Primary Product Color



| Contact Features | |
|---|-----------------------------|
| Contact Layout | Staggered |
| PCB Contact Termination Area Plating Material Thickness | 2 μm[80 μin] |
| Contact Underplating Material Thickness | 1.27 – 2.7 μm[50 – 106 μin] |
| Contact Mating Area Plating Material Thickness | 2 μm[80 μin] |
| PCB Contact Termination Area Plating Material Finish | Matte |
| Contact Mating Area Plating Material Finish | Matte |
| Contact Underplating Material | Nickel |
| PCB Contact Termination Area Plating Material | Tin |
| Contact Base Material | Brass |
| Contact Mating Area Plating Material | Tin |
| Contact Type | Pin |
| Contact Current Rating (Max) | 1 A |
| ermination Features | |
| Termination Method to Printed Circuit Board | Surface Mount |
| Mechanical Attachment | |
| Mating Alignment Type | Polarization |
| Mating Retention | With |
| PCB Mount Retention Type | Solder Peg |
| Mating Retention Type | Latch |
| Connector Mounting Type | Board Mount |
| Mating Alignment | With |
| PCB Mount Alignment | Without |
| PCB Mount Retention | With |
| Housing Features | |
| Mating Entry Location | Тор |
| Housing Material | LCP |
| Centerline (Pitch) | 1.25 mm[.049 in] |
| Jsage Conditions | |
| Operating Temperature Range | -40 - 105 °C[-40 - 221 °F] |
| Operation/Application | |
| Assembly Process Feature | Pick and Place Cover, Tape |
| | |



| Circuit Application | Power & Signal |
|------------------------|----------------|
| Industry Standards | |
| UL Flammability Rating | UL 94V-0 |
| Packaging Features | |

1600

Carton, Reel

Product Compliance

Packaging Quantity

Packaging Type

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Compliant with Exemptions |
|---|--|
| EU ELV Directive 2000/53/EC | Not Yet Reviewed |
| China RoHS 2 Directive MIIT Order No 32, 2016 | Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JAN 2022 (223) Candidate List Declared Against: JUL 2021 (219) SVHC > Threshold: Pb (4% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location. |
| Halogen Content | Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free |
| Solder Process Capability | Not reviewed for solder process capability |

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

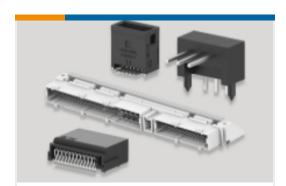




TE Part # 2-2390144-9
1.25P 9POS WTB CABLE HSG BL



Also in the Series | HPI



PCB Headers & Receptacles(362)

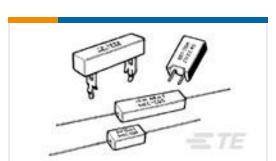


Wire-to-Board Connector Assemblies & Housings(139)



Wire-to-Board Connector Contacts(2)

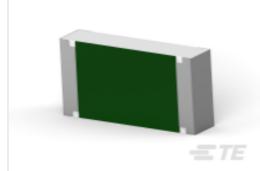
Customers Also Bought



TE Part #2-1623795-3 SQP2 R047 5% WIRE



TE Part #1-1630019-4 HSC200 2K4 5%



TE Part #9-2176397-4 3502 7K5 1%



TE Part #1-1969694-4
PTL 1X4 PCB HEADER R/A HITEMP
KEY A LGR



TE Part #YDTS24T15-18PNV001 RECP ASSY



TE Part #YDTS24T21-35SNV001 RECP ASSY



TE Part #YACT24ME35PNV00100

JAM NUT RECEPTACLE



TE Part #YD369-B99-AP400000 369 9 WAY PANEL MNT REC, 90 PCB GOLD,PIN



TE Part #YD369-B99-NP400000
369 9 WAY PANEL MNT REC, 90 PCB
GOLD,PIN



GOLD,SKT

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Documents

Product Drawings

1.25P 9POS WTB VERT BRD W LATCH TIN BL

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_4-2390138-9_1.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_4-2390138-9_1.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_4-2390138-9_1.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

English